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Electronic Filing System (EFS) Data

Electronic Patent Application Submission

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Application ID: 10812274



Title of Invention:
THIN INTEGRATED CIRCUIT
DEVICE PACKAGES FOR
IMPROVED RADIO FREQUENCY
PERFORMANCE

First Named Inventor: Sean Crowley

Domestic/Foreign Application: Domestic Application

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Submission Type:
Information Disclosure
Statement

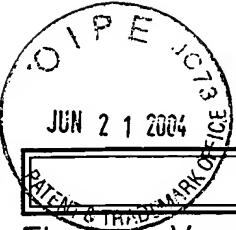
Filing Type:

Confirmation number: 2255

Attorney Docket Number: AMKOR022CB1

Total Fees Authorized:

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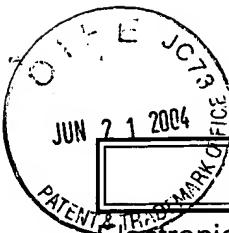


TRANSMITTAL

Electronic Version v1.1

Stylesheet Version v1.1.0

Title of Invention	THIN INTEGRATED CIRCUIT DEVICE PACKAGES FOR IMPROVED RADIO FREQUENCY PERFORMANCE	
Application Number:	10/812274	
Date:	2004-03-29	
First Named Applicant:	Sean T. Crowley	
Confirmation Number:	2255	
Attorney Docket Number:	AMKOR022CB1	
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Submitted by:	Elec. Sign.	Sign. Capacity
Mark B. Garred Registered Number: 34,823	/mbg/	Attorney
Documents being submitted	Files	
us-ids	ids2-usidst.xml	
	us-ids.dtd	
	us-ids.xsl	
Comments		



ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18

Stylesheet Version v18.0

Title of Invention	THIN INTEGRATED CIRCUIT DEVICE PACKAGES FOR IMPROVED RADIO FREQUENCY PERFORMANCE						
Application Number:	10/812274 						
Confirmation Number:	2255						
First Named Applicant:	Sean Crowley						
Attorney Docket Number:	AMKOR022CB1						
Art Unit:	2814						
Search string:	(5216278 or 5218231 or 5221642 or 5250841 or 5252853 or 5258094 or 5266834 or 5273938 or 5277972 or 5278446 or 5279029 or 5281849 or 5294897 or 5327008 or 5332864 or 5335771 or 5336931 or 5343076 or 5358905 or 5365106 or 5381042 or 5391439 or 5406124 or 5410180 or 5414299 or 5417905 or 5424576 or 5428248 or 5435057 or 5444301 or 5452511 or 5454905 or 5474958 or 5484274 or 5493151 or 5508556 or 5517056 or 5521429 or 5528076 or 5534467 or 5539251 or 5543657 or 5544412 or 5545923 or 5581122 or 5592019 or 5592025 or 5594274 or 5595934 or 5604376).pn.						
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Note: Applicant is not required to submit a paper copy of cited US Patent Documents							
init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass
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Signature

Examiner Name	Date